

| | | |
|------------|---|----------|
| V_{DSM} | = | 2800 V |
| I_{TAVM} | = | 5080 A |
| I_{TRMS} | = | 7970 A |
| I_{TSM} | = | 75000 A |
| V_{T0} | = | 0.86 V |
| r_T | = | 0.070 mW |

Phase Control Thyristor

5STP 45N2800

Doc. No. 5SYA1007-03 Aug.00

- Patented free-floating silicon technology
- Low on-state and switching losses
- Designed for traction, energy and industrial applications
- Optimum power handling capability
- Interdigitated amplifying gate.

Blocking

| Part Number | 5STP 45N2800 | 5STP 45N2600 | 5STP 45N2200 | Conditions |
|---------------------|---|--------------|--------------|----------------------------|
| V_{DRM} V_{RRM} | 2800 V | 2600 V | 2200 V | $f = 50$ Hz, $t_p = 10$ ms |
| V_{RSM1} | 3000 V | 2800 V | 2400 V | $t_p = 5$ ms, single pulse |
| I_{DRM} | ≤ 400 mA | | | $T_j = 125^\circ\text{C}$ |
| I_{RRM} | ≤ 400 mA | | | |
| dV/dt_{crit} | 1000 V/ μ s @ Exp. to $0.67 \times V_{DRM}$ | | | |

Mechanical data

| | | | |
|-------|---------------------------|------|----------------------|
| F_M | Mounting force | nom. | 90 kN |
| | | min. | 81 kN |
| | | max. | 108 kN |
| a | Acceleration | | |
| | Device unclamped | | 50 m/s ² |
| | Device clamped | | 100 m/s ² |
| m | Weight | | 2.9 kg |
| D_S | Surface creepage distance | | 56 mm |
| D_a | Air strike distance | | 22 mm |

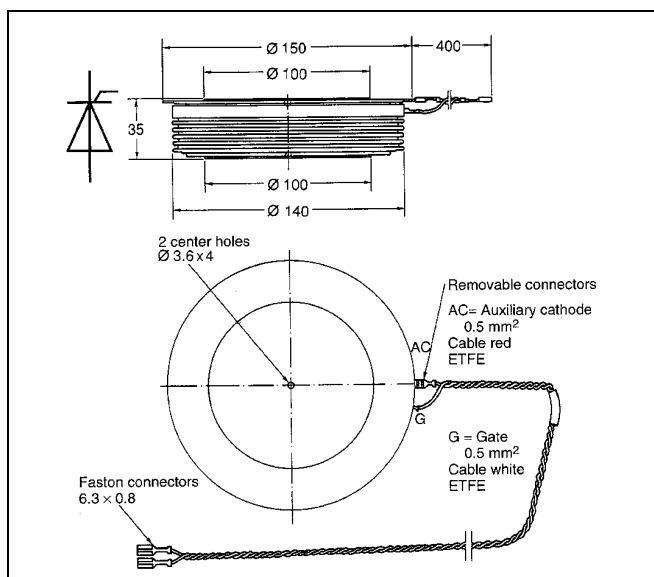


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On-state

| | | | | |
|------------|--|-----------------------------|--|--|
| I_{TAVM} | Max. average on-state current | 5080 A | Half sine wave, $T_C = 70^\circ\text{C}$ | |
| I_{TRMS} | Max. RMS on-state current | 7970 A | | |
| I_{TSM} | Max. peak non-repetitive surge current | 75000 A | $t_p = 10 \text{ ms}$ | $T_j = 125^\circ\text{C}$ After surge: $V_D = V_R = 0\text{V}$ |
| | | 79000 A | $t_p = 8.3 \text{ ms}$ | |
| I^2t | Limiting load integral | 28125 kA^2s | $t_p = 10 \text{ ms}$ | |
| | | 25900 kA^2s | $t_p = 8.3 \text{ ms}$ | |
| V_T | On-state voltage | 1.29 V | $I_T = 6000 \text{ A}$ | $T_j = 125^\circ\text{C}$ |
| V_{T0} | Threshold voltage | 0.86 V | $I_T = 3000 - 9000 \text{ A}$ | |
| r_T | Slope resistance | 0.070 $\text{m}\Omega$ | | |
| I_H | Holding current | 40-100 mA | $T_j = 25^\circ\text{C}$ | |
| | | 20-75 mA | $T_j = 125^\circ\text{C}$ | |
| I_L | Latching current | 100-500 mA | $T_j = 25^\circ\text{C}$ | |
| | | 150-350 mA | $T_j = 125^\circ\text{C}$ | |

Switching

| | | | | |
|----------------|---|----------------------------|---|---|
| di/dt_{crit} | Critical rate of rise of on-state current | 250 $\text{A}/\mu\text{s}$ | Cont. | $V_D \leq 0.67 \cdot V_{DRM}$ $T_j = 125^\circ\text{C}$ $I_{TRM} = 3000 \text{ A}$ $f = 50 \text{ Hz}$ $I_{FG} = 2.0 \text{ A}$ $t_r = 0.5 \mu\text{s}$ |
| | | 500 $\text{A}/\mu\text{s}$ | 60 sec. | |
| t_d | Delay time | $\leq 3.0 \mu\text{s}$ | $V_D = 0.4 \cdot V_{DRM}$ | $I_{FG} = 2.0 \text{ A}$ $t_r = 0.5 \mu\text{s}$ |
| t_q | Turn-off time | $\leq 400 \mu\text{s}$ | $V_D \leq 0.67 \cdot V_{DRM}$ $dv_D/dt = 20\text{V}/\mu\text{s}$ | $I_{TRM} = 3000 \text{ A}$ $T_j = 125^\circ\text{C}$ $V_R > 200 \text{ V}$ |
| Q_{rr} | Recovery charge | min | 4200 μAs | $di_T/dt = -5 \text{ A}/\mu\text{s}$ |
| | | max | 6500 μAs | |

Triggering

| | | | |
|-----------|---------------------------|--------|---------------------------|
| V_{GT} | Gate trigger voltage | 2.6 V | $T_j = 25^\circ\text{C}$ |
| I_{GT} | Gate trigger current | 400 mA | $T_j = 25^\circ\text{C}$ |
| V_{GD} | Gate non-trigger voltage | 0.3 V | $V_D = 0.4 \cdot V_{DRM}$ |
| I_{GD} | Gate non-trigger current | 10 mA | $V_D = 0.4 \cdot V_{DRM}$ |
| V_{FGM} | Peak forward gate voltage | 12 V | |
| I_{FGM} | Peak forward gate current | 10 A | |
| V_{RGM} | Peak reverse gate voltage | 10 V | |
| P_G | Maximum gate power loss | 3 W | |

Thermal

| | | | |
|--------------|--------------------------------------|-------------|---------------------|
| $T_{j\ max}$ | Max. junction temperature | 125°C | |
| $T_{j\ stg}$ | Storage temperature range | -40...150°C | |
| R_{thJC} | Thermal resistance junction to case | 11.4 K/kW | Anode side cooled |
| | | 11.4 K/kW | Cathode side cooled |
| | | 5.7 K/kW | Double side cooled |
| R_{thCH} | Thermal resistance case to heat sink | 2 K/kW | Single side cooled |
| | | 1 K/kW | Double side cooled |

Analytical function for transient thermal impedance:

$$Z_{thJC}(t) = \sum_{i=1}^n R_i(1 - e^{-t/\tau_i})$$

| | | | | |
|--------------|--------|--------|--------|--------|
| i | 1 | 2 | 3 | 4 |
| R_i (K/kW) | 3.4 | 1.26 | 0.68 | 0.35 |
| τ_i (s) | 0.8685 | 0.1572 | 0.0219 | 0.0078 |

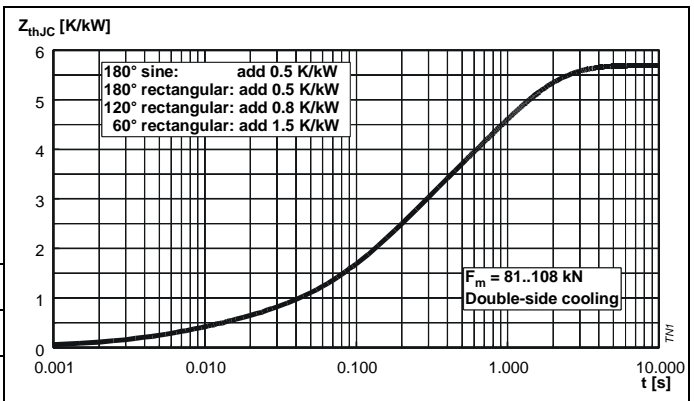


Fig. 1 Transient thermal impedance junction to case.

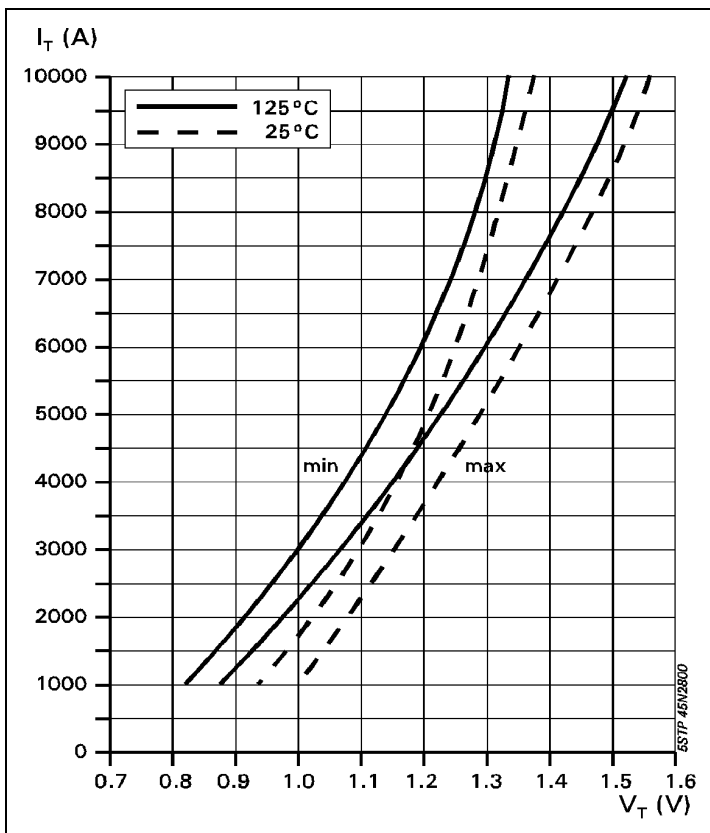


Fig 2. On-state characteristics.

On-state characteristic model:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

Valid for $i_T = 500 - 15000$ A

| | | | |
|-----------|----------|----------|-----------|
| A | B | C | D |
| -0.096289 | 0.000051 | 0.135731 | -0.001358 |

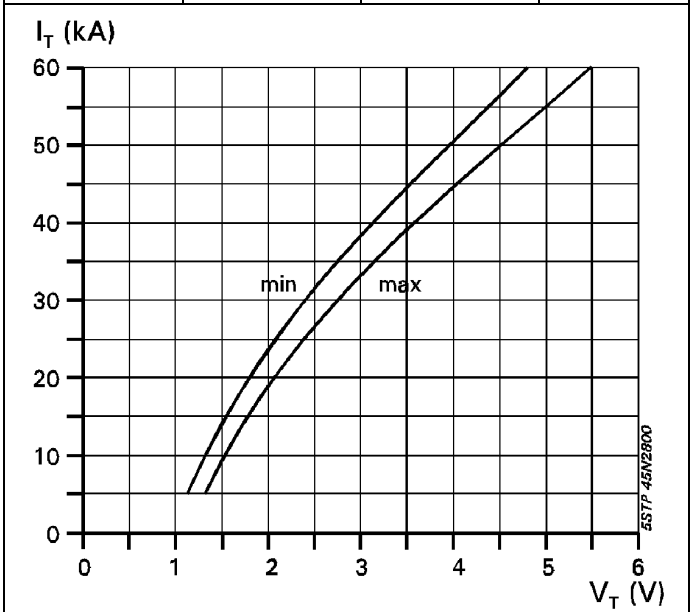


Fig. 3 On state characteristics.

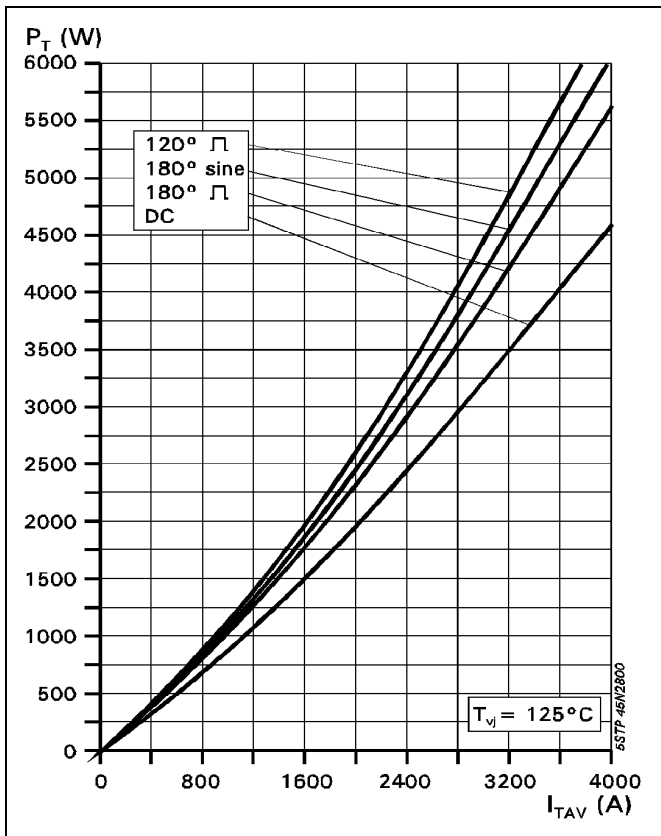


Fig. 4 On-state power dissipation vs. mean on-state current. Turn-on losses excluded.

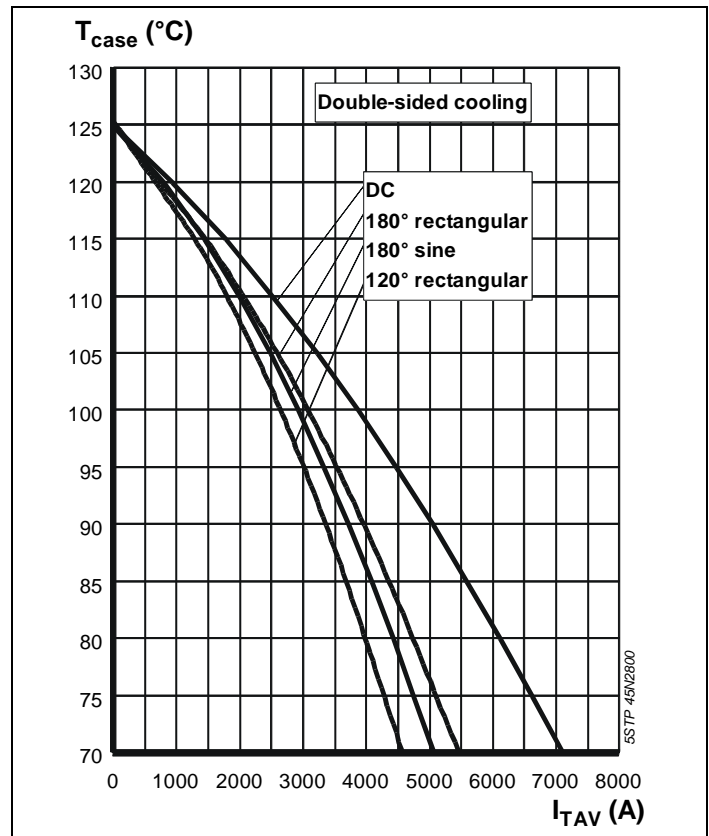


Fig. 5 Max. permissible case temperature vs. mean on-state current.

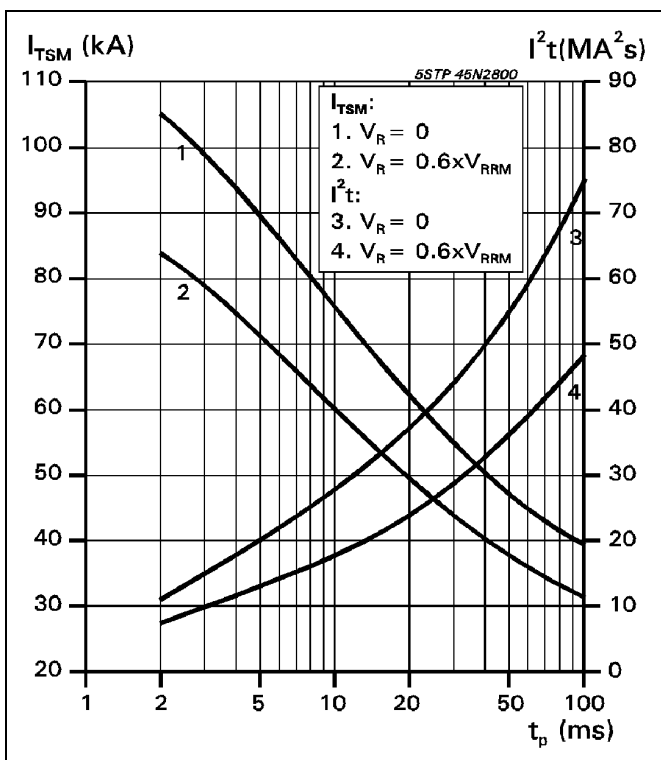


Fig. 6 Surge on-state current vs. pulse length. Half-sine wave.

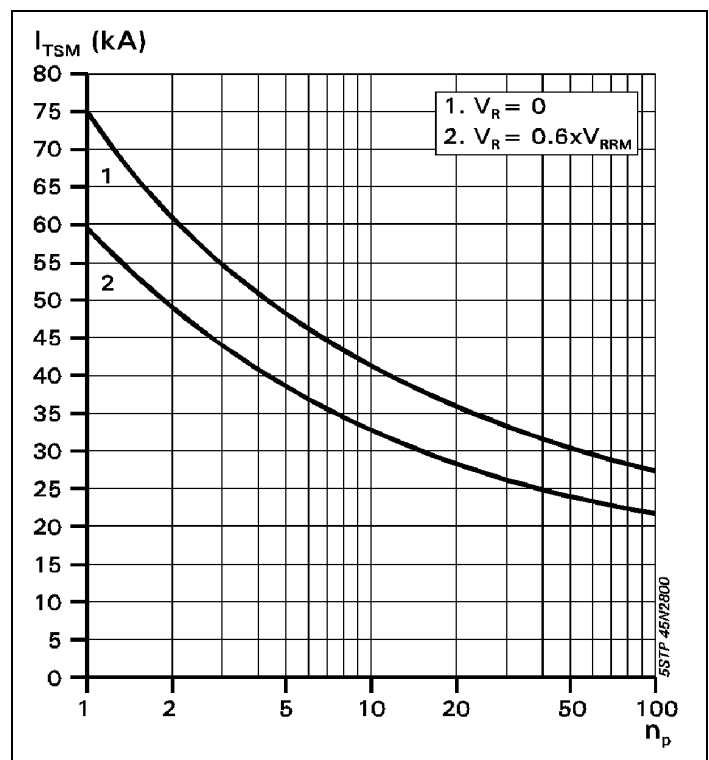


Fig. 7 Surge on-state current vs. number of pulses. Half-sine wave, 10 ms, 50Hz.

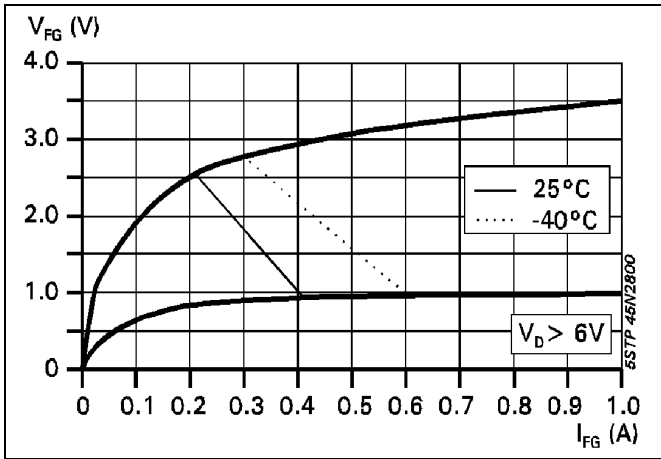


Fig. 8 Gate trigger characteristics.

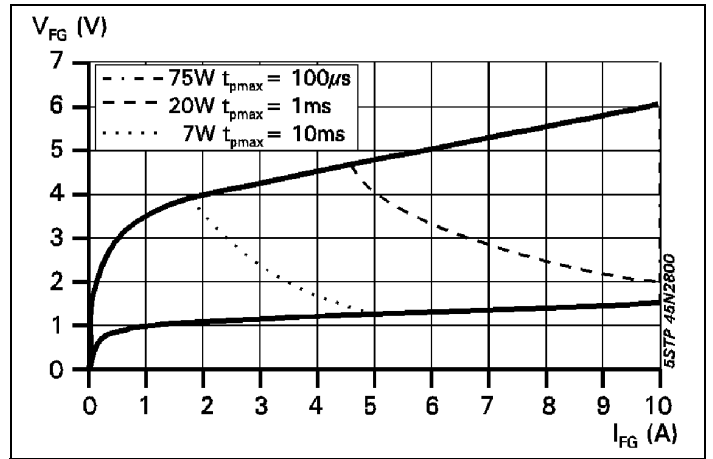


Fig. 9 Max. peak gate power loss.

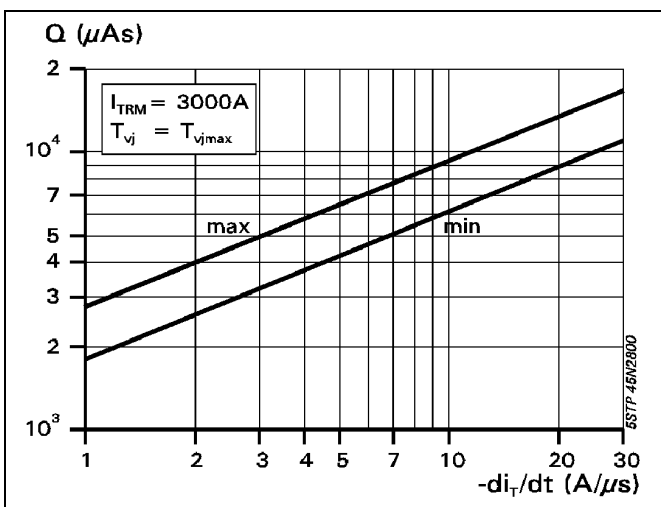


Fig. 10 Recovery charge vs. decay rate of on-state current.

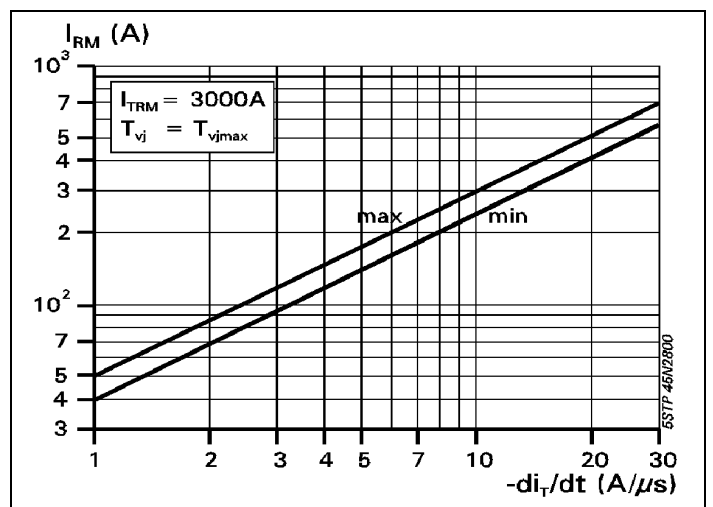


Fig. 11 Peak reverse recovery current vs. decay rate of on-state current.

Turn –off time, typical parameter relationship.

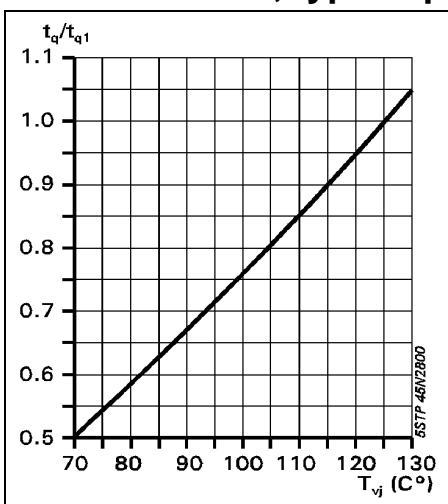


Fig. 12 $t_q/t_{q1} = f_1(T_j)$

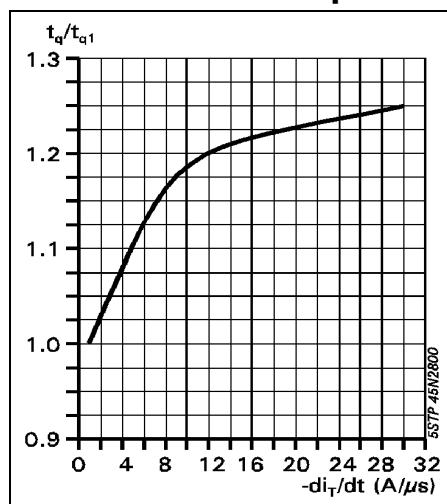


Fig. 13 $t_q/t_{q1} = f_2(-di/dt)$

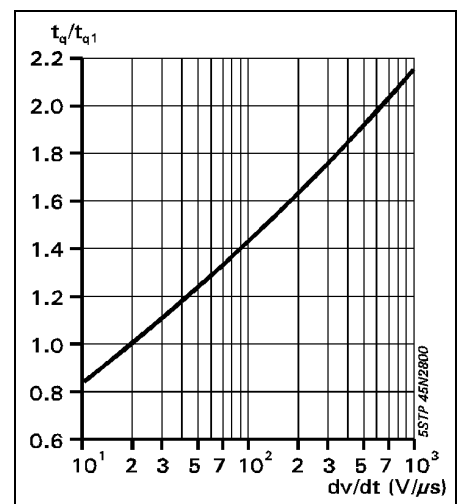


Fig. 14 $t_q/t_{q1} = f_3(dv/dt)$

$t_q = t_{q1} \cdot t_q/t_{q1} f_1(T_j) \cdot t_q/t_{q1} f_2(-di/dt) \cdot t_q/t_{q1} f_3(dv/dt)$ t_{q1} : at normalized values (see page 2)
 t_q : at varying conditions

Turn-on and Turn-off losses

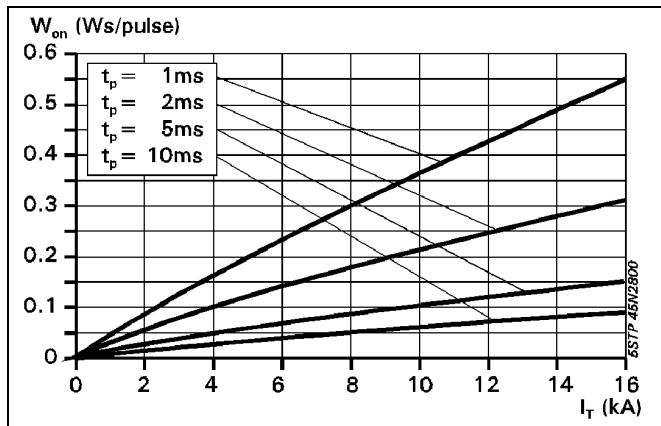


Fig. 15 $W_{on} = f(I_T, t_p)$, $T_j = 125^\circ\text{C}$.
Half sinusoidal waves.

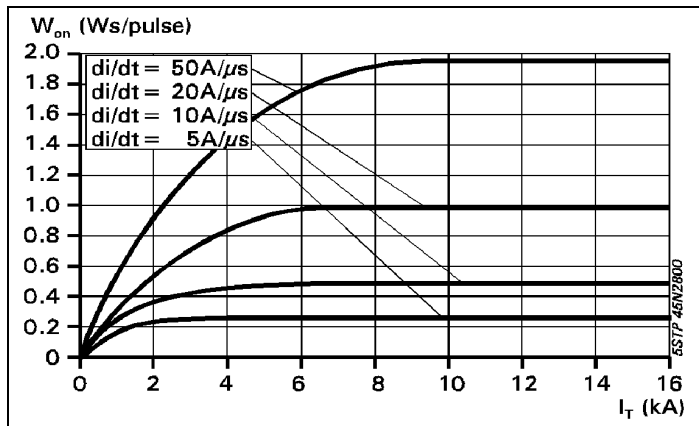


Fig. 16 $W_{on} = f(I_T, di/dt)$, $T_j = 125^\circ\text{C}$.
Rectangular waves.

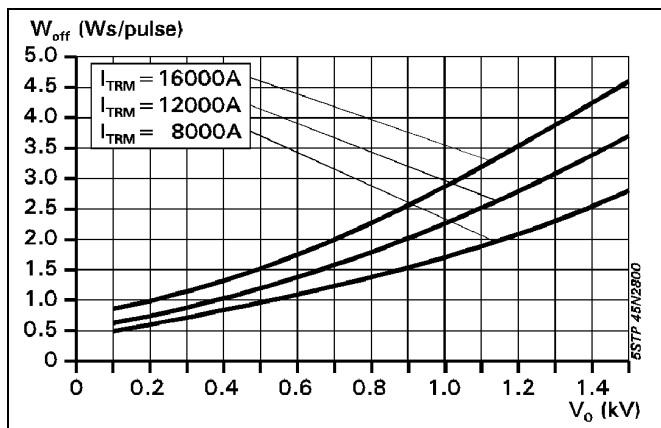


Fig. 17 $W_{off} = f(V_o, I_T)$, $T_j = 125^\circ\text{C}$.
Half sinusoidal waves. $t_p = 10$ ms.

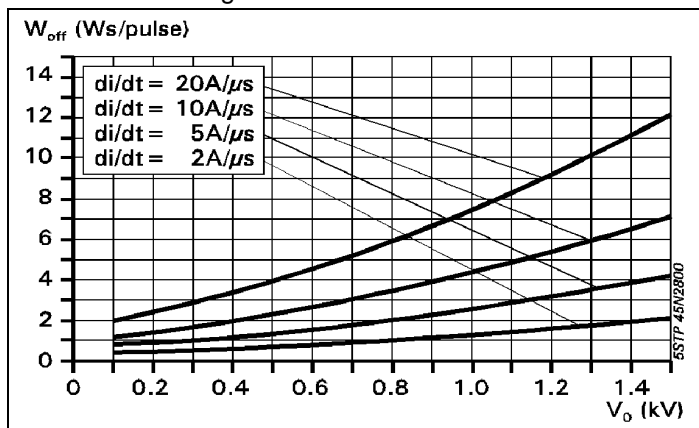


Fig. 18 $W_{off} = f(V_o, di/dt)$, $T_j = 125^\circ\text{C}$.
Rectangular waves.

$P_{TOT} = P_T + W_{on} * f + W_{off} * f$
 W_{off} at $V_{RRM} / V_o = 1.3-1.5$
 $P_T = \frac{1}{T} \int_0^T i_T * v_T dt$

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